# Sgi

SGI<sup>®</sup> Rackable<sup>™</sup> C3108-TY11 System User's Guide

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	About This Guide	•	•	•	•	•	•	•	•	•	•	•	•	•	•	•	•	•	•	.xvii
1	Introduction and System Compo	nei	nts (	Ove	rvie	w												•	•	. 1
	Racks																			. 3
	Componets																			. 3
	Chassis and Hard Drive Bays																			. 3
	Fans																			. 3
	Mounting Rails																			. 4
	Power Supply																			. 4
	Air Shroud																			. 4
	QuickPath Interconnect																			. 4
	Memory Subsystem																			. 6
	PCI Subsystem																			. 7
	Disk RAID Support																			. 7
	RAID 0 (Striping)																			. 8
	RAID 1 (Mirrored)																			. 8
	RAID 5 (Parity).																			. 8
	RAID 6 (Dual Parity)																			. 8
	RAID 10 (Mirrored Stripes)																			. 8
2	Installing the SCI Rackable C31	<u>08</u> _	тv	11 9	vet	m	in a	<b>R</b> a/	ek											11
4	Unpack the System	00-	11.	115	ysu		ша	Nav	LK	•	•	•	•	•	•	•	•	•	•	• • •
	Bropara for Satur	•	·	•	•	·	•	·	·	·	·	·	·	·	·	·	·	•	•	. 11
	Choose a Setup Logation	•	·	·	·	•	·	·	·	·	·	·	·	·	·	·	·	·	·	. 11
	Warnings and Propositions	·	•	•	•	•	•	•	•	•	•	•	•	•	•	•	•	•	•	. 11
	Back Presentions	·	•	•	•	·	•	•	•	•	•	•	•	•	•	•	•	•	•	. 12
	Rack Precautions	•	•	·	·	•	•	•	•	·	•	•	•	•	•	•	•	•	·	. 12
	Server Precautions	•	·	•	•	·	•	•	•	•	•	·	•	·	·	·	·	·	•	. 13
	Rack Mounting Considerations .	•	•	•	•	•	•	•	•	•	•	•	•	•	•	•	•	•	•	. 13

	Ambient Operating Temperature													. 13
	Reduced Airflow													. 13
	Mechanical Loading													. 13
	Circuit Overloading													. 14
	Reliable Ground													. 14
	Install the System into a Rack		•											. 14
	Separate the Sections of the Rack R	ails	<b>S</b> .	•						•		•		. 14
	Outer Rack Rails			•					•					. 15
	Install the Outer Rails to the Ra	ack		•					•					. 16
	Install the Inner Rail Extension .	•												. 17
	Install the Inner Rails								•					. 17
	Install the Server in a Rack								•					. 18
	Check the Node Board Setup													. 19
	Access the Inside of the Chassis.				•		•							. 19
	Check the CPUs (processors) .			•					•					. 20
	Check the System Memory								•					. 21
	Install Expansion PCI Cards			•					•					. 21
	Check all Cable Connections and A	irfl	ow		•									. 21
	Check the Drive Bay Setup													. 21
	Check the System Disk Drives		•											. 21
	Check the Airflow													. 22
	Supply Power to the System			•					•					. 22
3	System Safety						•	•	•				•	. 23
	Electrical Safety Precautions				•									. 23
	General Safety Precautions													. 24
	ESD Precautions						•							. 25
4	System Interface						•	•	•					. 27
	Overview													. 27
	Control Panel.													. 27
	Control Panel LEDs													. 28
	Power Fail													. 29
	Overheat/Fan Fail													. 29

	NIC1	 		 		. 29
	NIC2	 		 		. 30
	HDD	 		 		. 30
	Power	 		 		. 30
	SATA Drive Carrier LEDs	 • •		 		. 31
5	Chassis Setup and Maintenance	 	•	 	•	. 33
	Static-Sensitive Device	 		 		. 33
	Precautions	 		 		. 33
	Unpacking	 		 		. 34
	Removing the Chassis Cover	 		 		. 34
	Installing the Hard Drives	 		 		. 36
	Removing the Hard Drive Carriers from the Chassis .	 		 		. 38
	Installing a Hard Drive into the Hard Drive Carrier .	 		 		. 38
	PCI Expansion Slots.	 		 		. 40
	Installing an Add-On or Expansion Card	 		 		. 41
	Chassis Maintenance	 		 		. 41
	System Fans	 		 		. 42
	Replacing a Front Fan	 		 		. 42
	Replacing a Rear Fan	 		 		. 43
	Checking the System Air Flow	 		 		. 44
	Power Supply	 		 		. 44
	Replacing the Power Supply	 		 		. 45
	Replacing the Slim DVD-ROM Drive	 		 		. 46
6	BIOS	 	•	 	•	. 47
	Starting BIOS Setup Utility	 		 		. 47
	How To Change the Configuration Data	 		 		. 48
	Starting the Setup Utility	 		 		. 48
	Main Setup	 		 		. 48
	System Time/System Update	 		 		. 49
	Serverboard	 		 		. 49
	Processor	 		 		. 50
	System Memory	 		 		. 50

Advanced Setup Configurations .																		. 50
Boot Features																		. 51
Quick Boot																		. 51
Quiet Boot																		. 52
AddOn ROM Display M	ode																	. 52
Bootup Num-Lock																		. 52
Wait For 'F1' If Error .																		. 52
Hit 'Del' Message Displa	у.																	. 52
Interrupt 19 Capture .																		. 52
Power Configuration																		. 52
Power Button Function .																		. 53
Restore on AC Power Lo	oss .																	. 53
Watch Dog Timer																		. 53
Processor and Clock Options																		. 53
Ratio CMOS Setting .																		. 53
C1E Support											•							. 53
Hardware Prefetcher (Av	ailab	le w	hen	sup	por	ted	by tl	he C	CPU	)								. 54
Adjacent Cache Line Pre	fetch	(Av	aila	ble	whe	en su	appo	ortec	l by	the	CP	U)						. 54
Intel Virtualization Tech	nolog	y (A	Avai	labl	e wl	hen	sup	port	ed b	oy th	ne C	CPU	).					. 54
Execute-Disable Bit Cap	abilit	y (A	vail	lable	e wł	nen	supp	orte	ed b	y th	e O	S ai	nd ti	he C	CPU	).		. 54
Simultaneous Multi-Three	ading	g (A	vail	able	wh	en s	supp	orte	d by	y th	e C	PU)						. 54
Active Processor Cores.																		. 54
Intel EIST Technology .																		. 55
Intel TurboMode Techno	logy	(Av	aila	ble	whe	n In	tel l	EIST	ΓТє	echn	olo	gy i	s er	nable	ed)			. 55
Intel C-STATE Tech .																		. 55
C-State package limit set	ting (	Ava	ailat	ole v	vher	ı Int	el®	C-S	State	e Te	ch i	is er	nabl	ed)				. 55
C1 Auto Demotion																		. 55
C3 Auto Demotion																		. 55
Clock Spread Spectrum.	•																	. 55
Advanced Chipset Control .	•																	. 56
CPU Bridge Configuration	on.											•						. 56
Serial Debug Message Lo	evel											•						. 58
North Bridge Configuration .																		. 58

Crystal Beach/Direct Memory Access (DMA)	58
Crystal Beach/ Direct Cache Access (DCA)	59
Intel VT-d	59
SouthBridge Configuration	59
USB Functions	59
Legacy USB Support	59
USB 2.0 Controller	59
USB 2.0 Controller Mode	60
BIOS EHCI Hand-Off	60
Intel PCI-X Hub Configuration	60
PCI Bus A0/B0 Frequency	60
I/O Port Decode	60
RAS Sticky Error Handling . . . . . . . . .	60
VGA 16-Bit Decode	60
IDE and SATA Configuration	61
SATA#1 Configuration	61
Primary IDE Settings	61
Hot Plug	64
IDE Detect Timeout (sec)	64
PCI/PnP Configuration	64
Clear NVRAM	64
Plug & Play OS	64
PCI Latency Timer	65
PCI IDE BusMaster	65
Load Onboard LAN1 Option ROM/Load Onboard LAN2 Option ROM	65
Super IO Device Configuration.      . <th< td=""><td>65</td></th<>	65
Serial Port1 Address/ Serial Port2 Address	65
Remote Access Configuration      .<	65
Remote Access.	65
Hardware Health Monitor	67
CPU Overheat Alarm	67
CPU Temperature/System Temperature	67
ACPI Configuration	69

ACPI Version Features    6      ACPI APIC Support    6      APIC ACPI SCI IRQ    7      Headless Mode    7      High Performance Event Timer    7      Trusted Computing    7      Trusted Computing    7      IPMI Configuration    7      Status of BMC    7      View BMC System Event Log    7      Clear BMC System Event Log    7      Set LAN Configuration    7      Parameter Selector    7      Parameter Selector    7      Qurrent IP Address in BMC    7      Qurrent Mac Address in BMC    7      Subnet Mask    7      Stubnet Mask Configuration    7      Perf Configuration    7      Perf Configuration    7      Perf Support    7      Perf Startup Delay    7      PEF Altert Startup Delay    7      PE Startup Delay    7      Perf Startup Delay    7      Perf Startup Delay    7      Perf Startup Delay    7      Perf Startup Delay    7      Purent Log <t< th=""><th></th><th></th><th></th><th></th><th></th><th></th><th></th><th></th><th></th><th></th><th></th><th></th></t<>												
ACPI APIC Support    6      APIC ACPI SCI IRQ    7      Headless Mode    7      High Performance Event Timer    7      Trusted Computing    7      Trusted Computing    7      Trusted Computing    7      PMI Configuration    7      Status of BMC    7      View BMC System Event Log    7      Clear BMC System Event Log    7      Set LAN Configuration    7      Parameter Selector    7      Parameter Selector    7      Quirent IP Address in BMC    7      Quirent Mac Address in BMC    7      Subnet Mask Configuration    7      Subnet Mask Configuration    7      Subnet Mask Configuration    7      Parameter Selector    7      Puttin Mac Address in BMC    7      Subnet Mask    7      Statt D	ACPI Version Features											. 69
APIC ACPI SCI IRQ	ACPI APIC Support											. 69
Headless Mode	APIC ACPI SCI IRQ											. 70
High Performance Event Timer </td <td>Headless Mode</td> <td></td> <td></td> <td></td> <td></td> <td></td> <td></td> <td>•</td> <td>•</td> <td>•</td> <td></td> <td>. 70</td>	Headless Mode							•	•	•		. 70
Trusted Computing	High Performance Event Timer											. 70
TCG/TPM Support	Trusted Computing											. 70
IPMI Configuration    .	TCG/TPM Support											. 70
Status of BMC	IPMI Configuration											. 71
View BMC System Event Log	Status of BMC											. 71
Clear BMC System Event Log	View BMC System Event Log											. 71
Set LAN Configuration	Clear BMC System Event Log .											. 71
IP Address Configuration    . </td <td>Set LAN Configuration</td> <td></td> <td>. 72</td>	Set LAN Configuration											. 72
Parameter Selector </td <td>IP Address Configuration</td> <td></td> <td>. 72</td>	IP Address Configuration											. 72
IP Address	Parameter Selector											. 72
Current IP Address in BMC	IP Address											. 72
MAC Address Configuration    .<	Current IP Address in BMC .											. 72
Parameter Selector    .	MAC Address Configuration											. 73
Mac Address    . <td< td=""><td>Parameter Selector</td><td></td><td></td><td></td><td></td><td></td><td></td><td></td><td></td><td></td><td></td><td>. 73</td></td<>	Parameter Selector											. 73
Current Mac Address in BMC    .	Mac Address							•	•	•		. 73
Subnet Mask Configuration    .<	Current Mac Address in BMC .											. 73
Parameter Selector </td <td>Subnet Mask Configuration</td> <td></td> <td>. 73</td>	Subnet Mask Configuration											. 73
Subnet Mask    . <td< td=""><td>Parameter Selector</td><td></td><td></td><td>•</td><td></td><td>•</td><td></td><td></td><td></td><td></td><td></td><td>. 73</td></td<>	Parameter Selector			•		•						. 73
SEL PEF Configuration	Subnet Mask											. 73
PEF Support    . <td< td=""><td>SEL PEF Configuration</td><td></td><td></td><td></td><td></td><td></td><td></td><td></td><td></td><td></td><td></td><td>. 74</td></td<>	SEL PEF Configuration											. 74
PEF Action Global Control <td>PEF Support</td> <td></td> <td>. 74</td>	PEF Support											. 74
Alert Startup Delay    .	PEF Action Global Control											. 74
PEF Alert Startup Delay <t< td=""><td>Alert Startup Delay</td><td></td><td></td><td></td><td></td><td></td><td></td><td></td><td></td><td></td><td></td><td>. 74</td></t<>	Alert Startup Delay											. 74
Startup Delay    .    <	PEF Alert Startup Delay											. 74
PEF Startup Delay	Startup Delay											. 74
BMC Watch Dog Timer Action    .	PEF Startup Delay											. 75
DMI Event Log    .    <	BMC Watch Dog Timer Action											. 75
View Event Log	DMI Event Log				•	•		•	•	•		. 75
	View Event Log											. 75

Contents
----------

Mark all events as rea	d.			•	•									76
Clear event log.														76
Security Settings														76
Boot Configuration														77
Boot Device Priority .														78
Hard Disk Drives														79
Removable Drives														79
Exit Options														79
Save Changes and Exit .														80
Discard Changes and Exit														80
Discard Changes														81
Load Optimal Defaults .														81
Load Fail-Safe Defaults														81
BIOS Error Codes		•		•	•		•	•	•	•	•		•	83

A

# Figures

Figure 1-1	SGI Rackable C3108-TY11 Server
Figure 1-2	SGI Rackable C3108-TY11 Serverboard Block Diagram 2
Figure 1-3	QuickPath Interconnect Links
Figure 1-4	Memory Layout
Figure 2-1	Separating and Installing the Rack Rails
Figure 2-2	Square-to-round Hole Adapter for 2U Quick Attach Rails
Figure 2-3	Square-to-round Hole Adapter Clipped onto the Rail Set
Figure 2-4	Installing the Inner Rail Extensions
Figure 2-5	Installing the Server in a Rack
Figure 2-6	Accessing the Inside of the System
Figure 3-1	Installing the Onboard Battery
Figure 4-1	Control Panel Interface
Figure 4-2	Sysem Reset Button
Figure 4-3	System Power On Button
Figure 4-4	Power Fail LED
Figure 4-5	Overheat/Fan Fail LED
Figure 4-6	LAN1 Network Activity NIC1 LED.
Figure 4-7	LAN2 Network Activity NIC2 LED
Figure 4-8	Hard Drive Activity LED
Figure 4-9	Power On LED
Figure 5-1	Removing the Chassis Cover
Figure 5-2	Removing the Hard Drive Carriers
Figure 5-3	Removing the Dummy Drive from the Carrier
Figure 5-4	Installing a Drive into a Hard Drive Carrier
Figure 5-5	PCI Slot Location
Figure 5-6	Chassis Fans
Figure 5-7	Installing the Front Fan
Figure 5-8	Installing a Rear Fan

## Figures

Figure 6-1	System Overview Main BIOS Setup Screen	9
Figure 6-2	Advanced Settings Screen	1
Figure 6-3	<b>Security Settings</b> Screen	6
Figure 6-4	Boot Settings Screen	8
Figure 6-5	<b>Exit Options</b> Screen	0

# Tables

Table A-1	BIOS Error Codes																83
-----------	------------------	--	--	--	--	--	--	--	--	--	--	--	--	--	--	--	----

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# **About This Guide**

This guide provides an overview of the installation, architecture, general operation, and descriptions of the major components in the SGI® Rackable<sup>TM</sup> C3108-TY11 server. It also provides basic troubleshooting and maintenance information, BIOS information, and important safety and regulatory specifications.

## Audience

This guide is written for owners, installers, system administrators, and users of SGI Rackable C3108-TY11 computer systems. It is written with the assumption that the reader has a good working knowledge of computers and computer systems.

## **Related Publications**

The following SGI and LSI documents are relevant to the SGI Altix XE500 server:

- MegaRAID SAS Software User's Guide, publication number, 860-0488-00x
- *MegaRAID 1078-based SAS RAID Controllers User's Guide*, publication number 860-0489-00x
- LSI Integrated SAS for RAID User's Guide, publication number 860-0476-00x
- SGI ProPack 7 for Linux Start Here, publication number 007-5640-00x
- SGI InfiniteStorage series documentation
- Man pages (online)

You can obtain SGI documentation (as well as the pertinent LSI books), release notes, or man pages in the following ways:

- Refer to the SGI Technical Publications Library at http://docs.sgi.com. Various formats are available. This library contains the most recent and most comprehensive set of online books, release notes, man pages, and other information.
- You can also view man pages by typing **man** <*title*> on a command line.

SGI systems include a set of Linux<sup>®</sup> man pages, formatted in the standard UNIX<sup>®</sup> "man page" style. Important system configuration files and commands are documented on man pages. These are found online on the internal system disk (or DVD-CD) and are displayed using the man command. For example, to display the man page for the xscsidisktest command, type the following on a command line:

#### man xscsidisktest

For additional information about displaying man pages using the man command, see man(1).

In addition, the apropos command locates man pages based on keywords. For example, to display a list of man pages that describe disks, type the following on a command line:

#### apropos disk

For information about setting up and using apropos, see apropos(1).

## Conventions

The following conventions are used throughout this document:		
Convention	Meaning	
Command	This fixed-space font denotes literal items such as commands, files, routines, path names, signals, messages, and programming language structures.	
variable	The italic typeface denotes variable entries and words or concepts being defined. Italic typeface is also used for book titles.	
user input	This bold fixed-space font denotes literal items that the user enters in interactive sessions. Output is shown in nonbold, fixed-space font.	
[]	Brackets enclose optional portions of a command or directive line.	
	Ellipses indicate that a preceding element can be repeated.	
man page(x)	Man page section identifiers appear in parentheses after man page names.	
GUI element	This font denotes the names of graphical user interface (GUI) elements such as windows, screens, dialog boxes, menus, toolbars, icons, buttons, boxes, fields, and lists.	

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## Introduction and System Components Overview

The SGI Rackable C3108-TY11 server is a 3U rackmount server (see Figure 1-1). It features a unique and highly-optimized design for dual-core Xeon platforms. The chassis is equipped with a redundant 1200W high-efficiency power supply. High-performance fans provide ample optimized cooling for FB-DIMM memory modules and 8 hot-swappable drive bays offer maximum storage capacity.



Figure 1-1 SGI Rackable C3108-TY11 Server

The SGI Rackable C3108-TY11 server has the following configuration options:

- One or two 64-bit Intel Xeon Quad-core (Nehalem-EP) processors
- One to 18 memory DDR3 DIMMs
- Two full-height PCIe x16 slots (Slots 2 and 6) Gen 2.0
- Four full-height PCIe x8 slot (Slots 1, 3, 4, and 7)
- One PCIe UIO x4 slot (Slot 5 is a dedicated system RAID card slot)
- One Slimline DVD-ROM
- Eight hot-swappable SATA/SAS hard disk drives

The SGI Rackable C3108-TY11 serverboard chipset is made up of two main components: the Tylersburg IOH and the ICH10 controller hub See Figure 1-2.



Figure 1-2 SGI Rackable C3108-TY11 Serverboard Block Diagram

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## Racks

The following rack assemblies are available:

Short rack

The 20U-high deskside rack holds a maximum of six 3U-high enclosures.

• 39U tall rack

The 39U-high rack holds a maximum of 13 3U-high enclosures.

• 42U water-cooled tall rack

The 42U-high water-cooled rack holds a maximum of 13 3U-high enclosures. Only 40U of the 42U is water cooled. There is 40U in the main section of the rack and the 2U is located between the top plate and the top cover.

**Note:** Adding switches to the rack configuration will reduce the maximum number of SGI Rackable C3108-TY11 servers supported in a rack.

## Componets

This section describes the major components of the SGI Rackable C3108-TY11 system.

## **Chassis and Hard Drive Bays**

The SGI Rackable C3108-TY11 system has one slim 8x DVD and includes eight hard drive bays.

## Fans

The SGI Rackable C3108-TY11 system accepts three 8cm hot-swappable fans and two 8cm rear exhaust fans. System fans for SGI Rackable C3108-TY11 chassis are powered from the serverboard. These fans are 3U compatible and are powered by 3-pin connectors.

Mounting Rails	
	The SGI Rackable C3108-TY11 system is shipped with mounting rails. See Chapter 2, "Installing the SGI Rackable C3108-TY11 System in a Rack.", to setup your rack.
Power Supply	
	Each SGI Rackable C3108-TY11 system includes two redundant high-efficiency hot-swappable power supplies rated at 1200 Watts. In the unlikely event of a failure in one of the power supplies, you can remove and replace the faulty power supply without powering down the system.
Air Shroud	
	Air shrouds are shields, usually plastic, that funnel air directly to where it is needed.
	<b>Important:</b> Always use the air shroud included with your system.

## **QuickPath Interconnect**

The Intel Nehalem-EP processor has two QuickPath Interconnect (QPI) links (see Figure 1-3). The QPI link consists of two point to point 20 bit channels - one send channel and one receive channel. The QPI link has a theoretical maximum aggregate bandwidth of 25.6 GB/s.



Figure 1-3 QuickPath Interconnect Links

The maximum bandwidth of a single QPI link is calculated as follows:

- The QPI channel uses a 3.2 GHz clock, but the effective clock rate is 6.4 GHz because two bits are transmitted at each clock period -once on the rising edge of the clock and once on the falling edge (DDR).
- Of the 20 bits in the channel, 16 bits are data and 4 bits are error correction.
- 6.4 GHz times 16 bits equals 102.4 bits per clock period.
- Convert to bytes: 102.4 divided by 8 equals 12.8 GB/s (the maximum single direction bandwidth)
- The total aggregate bandwidth of the QPI channel is 25.6 GB/s: (12.8 GB/s times 2 channels)

The Tylersburg chip set supports two Nehalem-EP processors. Each processor is connected to one of the Tylersburg chips with a QPI channel. The two processors and the Tylersburg chips are also connected together with a single QPI channel.

## **Memory Subsystem**

The Nehalem-EP memory controller supports three DDR3 memory channels. Each channel can support up to three DDR3 SDRAM DIMMs for a total of nine memory DIMMs. The node board can support up to 18 DIMMs or a maximum memory size of 144 GB physical memory. A total of 72 bits of data are transferred each clock period: 64 bits of data and 8 bits for error correction

See Figure 1-4 for the memory layout.





The memory bandwidth is determined by three key factors:

- The processor speed different processor SKUs support different DIMM speeds. Current processors support either 1066 or 1333.
- The DIMM speed the DIMM itself has a maximum operating frequency or speed. Currently there are two DIMM speeds: 1066 and 1333.
- The number of DIMMs per channel the maximum memory channel speed is as follows:
  - One DIMM per channel 1333 MT/s maximum
  - Two DIMMs per channel 1066 MT/s maximum
  - Three DIMMs per channel 800 MT/s maximum

**Note:** The DIMM must be rated for the maximum speed to be able to run at the maximum speed. Example: a single 1066 MT/s DIMM on a channel will only operate at 1066 MT/s - not 1333 MT/s.

Populating one 1333 MT/s DIMM on each channel delivers a maximum of 10.66 GB/s per channel or 31.99 GB/s total memory bandwidth.

## **PCI Subsystem**

The primary I/O buses for the server board is PCI Express.

## **Disk RAID Support**

The SGI Rackable C3108-TY11 supports both software and hardware RAID. One of two SAS RAID HBAs are added to the configuration to support a maximum of eight disk drives with RAID.

In the standard RAID configuration (LSX-BASE-500), the SAS3081e-r HBA is installed in the chassis. This HBA supports RAID 0, 1E, and 10E.

The optional configuration is selected by ordering LSX-BASE-500-RAID5. The SAS3081e-r HBA is replaced with MegaRAID 8708ELP. This HBA supports all of the RAID levels in the standard configuration with the addition of RAID 5 and RAID 6.

RAID is defined as an array of multiple independent hard disk drives that provides high performance and fault tolerance. Disk performance is improved because more than one disk can be accessed simultaneously. Fault tolerance is improved because data loss caused by a hard drive failure can be recovered by rebuilding missing data from the remaining data or parity drives.

The SGI Rackable C3108-TY11 supports the following RAID levels:

- RAID 0 Striping
- RAID 1 Mirrored
- RAID 5 Parity
- RAID 6 Parity

	RAID 10 Mirrored Stripes	
RAID 0 (Striping)		
	Disk striping allows the writing of data across multiple physical disks instead of just one physical disk. It involves partitioning each disk drive storage space into stripes that can vary in size from 8KB to 128KB.	
RAID 1 (Mirrored)		
	Disk mirroring has two disks, data is written simultaneously to both disks. If one disk fails, the contents of the disk can be used to run the system and reconstruct the failed disk.	
RAID 5 (Parity)		
	RAID 5 stripes both data and parity information across three or more drives. Fault tolerance is maintained by ensuring that the parity information for any given block of data is placed on a drive separate from those used to store the data itself. The performance of a RAID 5 array can be "adjusted" by trying different stripe sizes until one is found that is well-matched to the application being used.	
RAID 6 (Dual Parity)		
	Striped set with dual distributed parity. Provides fault tolerance from two drive failures; array continues to operate with up to two failed drives. With dual parity, it gives time to rebuild the array without the data being volatile while the failed drive is being recovered.	
RAID 10 (Mirrored Stripes)		
	<b>RAID</b> 10 is a combination of <b>RAID</b> 1 and <b>RAID</b> 0 <b>RAID</b> 10 is a string across a number of	

RAID 10 is a combination of RAID 1 and RAID 0. RAID 10 is a stripe across a number of mirrored sets. It combines the best features of striping and mirroring to yield large arrays with high performance in most uses and superior fault tolerance.

Disk RAID Support

Chapter 2

# Installing the SGI Rackable C3108-TY11 System in a Rack

This chapter provides a quick setup checklist to get the SGI Rackable C3108-TY11 system operational.

## **Unpack the System**

Inspect the shipping container that the SGI Rackable C3108-TY11 system was shipped in and note if it was damaged in any way. If the server shows damage, file a damage claim with the carrier who delivered it.

Decide on a suitable location for the rack that supports the weight, power requirements, and environmental requirements of the SGI Rackable C3108-TY11 server. It should be situated in a clean, dust-free environment that is well ventilated. Avoid areas where heat, electrical noise, and electromagnetic fields are generated. Place the server rack near a grounded power outlet. Refer to "Warnings and Precautions" on page 12.

## **Prepare for Setup**

The shipping container should include two sets of rail assemblies, two rail mounting brackets and the mounting screws that you will use to install the system into a rack.

Read this section in its entirety before you begin the installation procedure.

#### **Choose a Setup Location**

Leave enough clearance in front of the rack to enable you to open the front door completely (~25 inches) and approximately 30 inches of clearance in the back of the rack to allow for sufficient airflow and ease in servicing.

## Warnings and Precautions

## **Rack Precautions**



**Warning:** The SGI Rackable C3108-TY11 server weighs 57 lbs (26 kg). Always use proper lifting techniques when your move the server. Always get the assistance of another qualified person when you install the sever in a location above your shoulders. Failure to do so may result in serious personal injury or damage to the equipment.

- Extend the leveling jacks on the bottom of the rack to the floor with the full weight of the rack resting on them. Failure to do so can result in serious injury or death.
- Attach stabilizers to the rack in single rack installations. Failure to do so can result in serious injury or death.
- Couple racks together in multiple rack installations. Failure to do so can result in serious injury or death.
- Be sure the rack is stable before extending a component from the rack. Failure to do so can result in serious injury or death.
- Extend only one component at a time. Extending two or more components simultaneously may cause the rack to tip over and result in serious injury or death.

#### **Server Precautions**

- Review the electrical and general safety precautions.
- Determine the placement of each component in the rack before you install the rails.
- Install the heaviest server components in the bottom of the rack first, and then work up.
- Use a regulating uninterruptible power supply (UPS) to protect the server from power surges and voltage spikes and to keep your system operating in case of a power failure.
- Allow the hot-pluggable SAS/SATA drives and power supply modules to cool before touching them.
- Always keep the rack's front door and all panels and components on the servers closed when not servicing to maintain proper cooling.

## **Rack Mounting Considerations**

#### Ambient Operating Temperature

If installed in a closed or multi-unit rack assembly, the ambient operating temperature of the rack environment may be greater than the ambient temperature of the room. Therefore, consideration should be given to installing the equipment in an environment compatible with the manufacturer's maximum rated ambient temperature (35° C or 95° F).

## **Reduced Airflow**

Equipment should be mounted into a rack so that the amount of airflow required for safe operation is not compromised.

#### Mechanical Loading

Equipment should be mounted into a rack so that a hazardous condition does not arise due to uneven mechanical loading.

## Circuit Overloading

Consideration should be given to the connection of the equipment to the power supply circuitry and the effect that any possible overloading of circuits might have on overcurrent protection and power supply wiring. Appropriate consideration of equipment nameplate ratings should be used when addressing this concern.

#### **Reliable Ground**

A reliable ground must be maintained at all times. To ensure this, the rack itself should be grounded. Particular attention should be given to power supply connections other than the direct connections to the branch circuit (for example, the use of power strips, and so on).

## Install the System into a Rack

This section provides information on installing the SGI Rackable C3108-TY11 into a rack. If the system has already been mounted into a rack, refer to "Check the Node Board Setup" on page 19. There are a variety of rack units on the market, which may mean the assembly procedure will differ slightly. You should also refer to the installation instructions that came with the rack unit you are using.

#### Separate the Sections of the Rack Rails

The chassis package includes two rail assemblies in the rack mounting kit. Each assembly consists of two sections: an inner fixed chassis rail that secures directly to the server chassis and an outer fixed rack rail that secures directly to the rack itself.

To separte the inner and outer rails, perform the following steps:

- 1. Locate the rail assembly in the chassis packaging as shown in Figure 2-1.
- 2. Extend the rail assembly by pulling it outward.
- 3. Press the quick-release tab
- 4. Separate the inner rail from the outer rail assembly.



## **Outer Rack Rails**

Outer rails attach to the rack and hold the chassis in place. The outer rails for the chassis extend between 30 inches and 33 inches. You need to add the square-to-round hole adapters that attach

to the ends of the 2U quick attach rails. Figure 2-2 shows the rail adapter and the end of the quick attach rail.



Figure 2-2 Square-to-round Hole Adapter for 2U Quick Attach Rails

Figure 2-3 shows the adapter clipped onto the rail set. Use the flat head M5 screws supplied with the rails kit to bolt the rails set into the rack.



Figure 2-3 Square-to-round Hole Adapter Clipped onto the Rail Set

#### Install the Outer Rails to the Rack

- 5. Secure the back end of the outer rail to the rack, using the screws provided (see Figure 2-1).
- 6. Press the button where the two outer rails are joined to retract the smaller outer rail.
- 7. Hang the hooks of the rails onto the rack holes and if desired, use screws to secure the front of the outer rail onto the rack.
- 8. Repeat steps 1-3 for the remaining outer rail.
### Install the Inner Rail Extension

The SGI Rackable C3108-TY11 chassis includes a set of inner rails in two sections: inner rails and inner rail extensions. The inner rails are pre-attached to the chassis, and do not interfere with normal use of the chassis if you decide not to use a server rack The inner rail extension is attached to the inner rail to mount the chassis in the rack.

#### Install the Inner Rails

Perform the following steps to install the inner rails:

- 1. Place the inner rail extensions on the side of the chassis aligning the hooks of the chassis with the rail extension holes. Make sure the extension faces "outward" just like the pre-attached inner rail (see Figure 2-4)
- 2. Slide the extension toward the front of the chassis.
- 3. Secure the chassis with 2 screws as illustrated. Repeat steps for the other inner rail extension.



Figure 2-4 Installing the Inner Rail Extensions

### Install the Server in a Rack



**Warning:** The SGI Rackable C3108-TY11 server weighs 57 lbs (26 kg) Always use proper lifting techniques when your move the server. Always get the assistance of another qualified person when you install the sever in a location above your shoulders. Failure to do so may result in serious personal injury or damage to the equipment.

You should now have rails attached to both the server chassis and the rack unit. The next step is to install the server into the rack (refer to Figure 2-5).

- 1. Extend the outer rails as shown in Figure 2-5.
- 2. Align the inner rails of the chassis with the outer rails on the rack.
- 3. Slide the inner rails into the outer rails, keeping the pressure even on both sides. When the chassis has been pushed completely into the rack, it should click into the locked position.
- 4. Optional screws may be used to secure the to hold the front of the chassis to the rack.



Figure 2-5 Installing the Server in a Rack

# **Check the Node Board Setup**

Use the following sections to open the top cover and check that each node board is properly installed and all the connections have been made.

### Access the Inside of the Chassis

- 1. Grasp the two handles on either side and pull the unit straight out until it locks (you will hear a "click").
- 2. Depress the two buttons on the top of the chassis to release the top cover as shown in Figure 2-6.
- 3. Lift the top cover from the chassis.

**Note:** To remove the system from the rack completely, depress the locking tabs on the chassis rails (push the right-side tab down and the left-side tab up) to continue to pull the system out past the locked position.



Figure 2-6 Accessing the Inside of the System

# Check the CPUs (processors)

You may have one or two processors installed into the serverboard. Each processor needs its own heatsink.

### **Check the System Memory**

Your server system is shipped with system memory installed. Make sure all DIMMs are fully seated in their slots.

### Install Expansion PCI Cards

You can install six expansion PCI cards in the system.

### **Check all Cable Connections and Airflow**

Make sure all power and data cables are properly connected and not blocking the chassis airflow.

#### **Check the Drive Bay Setup**

Next, you should check to make sure the system disk drives and disk drive backplane have been properly installed and all connections have been made.

#### **Check the System Disk Drives**

All drives are accessible from the front of the server. For servicing the DVD-ROM, you will need to remove the top chassis cover. The hard drives can be installed and removed from the front of the chassis without removing the top chassis cover. Depending upon your system configuration, your system may have one or more drives installed.

If you have more than 4TB of storage, you must create multiple volumes to fully utilize your RAID disks.

Refer to the *MegaRAID SAS Software User's Guide*, SGI publication number 860-0488-00x and the *MegaRAID 1078-based SAS RAID Controllers User's Guide*, SGI publication number 860-0489-00x for more information about configuring your system disks.

A slim DVD-ROM may be preinstalled in your server.

Depending upon your system's configuration, your system may have one or more drives already installed.

#### **Check the Airflow**

Airflow is provided by five hot-swappable 8-cm chassis cooling fans. The system component layout was carefully designed to direct sufficient cooling airflow to the components that generate the most heat.

**Note:** Make sure that all power and data cables have been routed in such a way that they do not block the airflow generated by the fans.

#### Supply Power to the System

If necessary, install the system in a rack (refer to "Install the System into a Rack" on page 14), and connect the power cord from the power supply module into a power strip or power distribution unit (PDU). SGI also recommends that you use an uninterruptible power supply (UPS) source.

Chapter 3

# System Safety

This chapter describes basic safety precautions.

# **Electrical Safety Precautions**

Basic electrical safety precautions should be followed to protect yourself from harm and the SGI Rackable C3108-TY11 system from damage, as follows:

• Be aware of the locations of the power on/off switch on the chassis as well as the room's emergency power-off switch, disconnection switch or electrical outlet. If an electrical accident occurs, you can then quickly remove power from the system.

• Do not work alone when working with high voltage components.

• Power should always be disconnected from the system when removing or installing main system components, such as the serverboard, memory modules and SATA drives. When disconnecting power, you should first power down the operating system first and then unplug the power cords. The unit has more than one power supply cord. Disconnect two power supply cords before servicing to avoid electrical shock.

• When working around exposed electrical circuits, another person who is familiar with the power-off controls should be nearby to switch off the power if necessary.

• Use only one hand when working with powered-on electrical equipment. This is to avoid making a complete circuit, which will cause electrical shock. Use extreme caution when using metal tools, which can easily damage any electrical components or circuit boards they come into contact with.

• Do not use mats designed to decrease static electrical discharge as protection from electrical shock. Instead, use rubber mats that have been specifically designed as electrical insulators.

• The power supply power cords must include a grounding plug and must be plugged into grounded electrical outlets.

· Serverboard Battery



**Caution:** There is a danger of explosion if the onboard battery is installed upside down, which will reverse its polarites (see Figure 3-1). This battery must be replaced only with the same or an equivalent type recommended by the manufacturer. Dispose of used batteries according to the manufacturer's instructions.

• DVD-ROM Laser



**Caution:** This server may have come equipped with a DVD-ROM drive. To prevent direct exposure to the laser beam and hazardous radiation exposure, do not open the enclosure or use the unit in any unconventional way.



Figure 3-1 Installing the Onboard Battery

# **General Safety Precautions**

Follow these rules to ensure general safety:

- Keep the area around the SGI Rackable C3108-TY11 system clean and free of clutter.
- Place the chassis top cover and any system components that have been removed away from the system or on a table so that they won't accidentally be stepped on.
- While working on the system, do not wear loose clothing such as neckties and unbuttoned shirt sleeves, which can come into contact with electrical circuits or be pulled into a cooling fan.

- Remove any jewelry or metal objects from your body, which are excellent metal conductors that can create short circuits and harm you if they come into contact with printed circuit boards or areas where power is present.
- After accessing the inside of the system, close the system back up and secure it to the rack unit with the retention screws after ensuring that all connections have been made.

# **ESD Precautions**



**Caution:** Electrostatic discharge (ESD) is generated by two objects with different electrical charges coming into contact with each other. An electrical discharge is created to neutralize this difference, which can damage electronic components and printed circuit boards.

The following measures are generally sufficient to neutralize this difference before contact is made to protect your equipment from ESD:

- Use a grounded wrist strap designed to prevent static discharge.
- Keep all components and printed circuit boards (PCBs) in their antistatic bags until ready for use.
- Touch a grounded metal object before removing the board from the antistatic bag.
- Do not let components or PCBs come into contact with your clothing, which may retain a charge even if you are wearing a wrist strap.
- Handle a board by its edges only; do not touch its components, peripheral chips, memory modules or contacts.
- When handling chips or modules, avoid touching their pins.
- Put the serverboard and peripherals back into their antistatic bags when not in use.
- For grounding purposes, make sure your computer chassis provides excellent conductivity between the power supply, the case, the mounting fasteners and the serverboard.

Chapter 4

# **System Interface**

## **Overview**

There are several LEDs on the control panel (see Figure 4-1) as well as others on the SATA drive carriers (see "SATA Drive Carrier LEDs" on page 31) to keep you constantly informed of the overall status of the system as well as the activity and health of specific components. There are also two buttons on the chassis control panel.



 Figure 4-1
 Control Panel Interface

# **Control Panel**

There are two buttons located on the front of the chassis: a reset button and a power on/off button. Use the reset button to reboot the system as shown in Figure 4-2.



Figure 4-2 Sysem Reset Button

Figure 4-3 shows the the main power button, which is used to apply or turn off the main system power. Turning off system power with this button removes the main power but keeps standby power supplied to the system.



Figure 4-3 System Power On Button

# **Control Panel LEDs**

The control panel located on the front of the chassis has several LEDs. These LEDs provide you with critical information related to different parts of the system. This section explains what each LED indicates when illuminated and any corrective action you may need to take.

### **Power Fail**

The red power fail LED indicates a power supply module has failed as shown in Figure 4-4. The second power supply module will take the load and keep the system running but the failed module will need to be replaced. Refer to Chapter 6 for details on replacing a power supply. This LED should be off when the system is operating normally.



Figure 4-4 Power Fail LED

### **Overheat/Fan Fail**

When the red overheat/fan LED flashes (shown in Figure 4-5), it indicates a fan failure. When on continuously it indicates an overheat condition, which may be caused by cables obstructing the airflow in the system or the ambient room temperature being too warm. Check the routing of the cables and make sure all fans are present and operating normally. You should also check to make sure that the chassis covers are installed. This LED will remain flashing or on as long as the indicated condition exists.



Figure 4-5 Overheat/Fan Fail LED

NIC1

When flashing, the green NIC1 LED indicates network activity on the LAN1 port (see Figure 4-6).







#### Figure 4-9 Power On LED

# **SATA Drive Carrier LEDs**

Each SATA drive carrier has two LEDs, as follows:

- **Green**: When illuminated, the green LED on the SATA drive carrier indicates drive activity. A connection to the SATA backplane enables this LED to blink on and off when that particular drive is being accessed. Please refer to Chapter 5 for instructions on replacing failed drives.
- **Red**: The red LED indicates a SATA drive failure. If one of the drives fails, you should be notified by your system management software. Please refer to Chapter 5 for instructions on replacing failed drives.

# **Chassis Setup and Maintenance**

This chapter covers the steps required to install components and perform maintenance on the SGI Altix Rackable C3108-TY11 chassis. For component installation, follow the steps in the order given to eliminate the most common problems encountered. If some steps are unnecessary, skip ahead to the step that follows.

**Tools Required**: The only tool you will need to install components and perform maintenance is a Phillips screwdriver.



**Warning:** Review the warnings and precautions listed in the manual before setting up or servicing this chassis. These include information in Chapter 2: System Safety and the warning/precautions listed in the setup instructions.

# **Static-Sensitive Device**

Electrostatic discharge (ESD) can damage electronic components. To prevent damage to any printed circuit boards (PCBs), it is important to handle them very carefully. The following measures are generally sufficient to protect your equipment from ESD damage.

### Precautions

- Use a grounded wrist strap designed to prevent static discharge.
- Touch a grounded metal object before removing any board from its antistatic bag.
- Handle a board by its edges only; do not touch its components, peripheral chips, memory modules or gold contacts.
- When handling chips or modules, avoid touching their pins.

• Put the serverboard, add-on cards and peripherals back into their antistatic bags when not in use.

• For grounding purposes, make sure your computer chassis provides excellent conductivity between the power supply, the case, the mounting fasteners and the serverboard.

## Unpacking

The serverboard is shipped in antistatic packaging to avoid static damage. When unpacking the board, make sure the person handling it is static protected.

# **Removing the Chassis Cover**

To remove the chassis cover, perform the following steps:

- 1. Press the release tabs to release the cover from the locked position. Press both tabs at the same time. It may also be necessary to remove the chassis cover screw (see Figure 5-1).
- 2. Once the top cover is released from the locked position, slide the cover toward the rear of the chassis and lift the cover off the unit.

Removing the Chassis Cover



Figure 5-1 Removing the Chassis Cover



**Warning:** Except for short periods of time, do NOT operate the server without the cover in place. The chassis cover must be in place to allow proper airflow and prevent overheating.

## **Installing the Hard Drives**

The SGI Rackable C3108-TY11 has three disk storage configurations:

- LSX-BASE-500 and LSX-BASE-500-H support RAID 0, 1E, and 10E for both SAS and SATA drives
- LSX-BASE-500-RAID5 and LSX-BASE-500-RAID5-H support RAID 0, 1, 5, 6, 10, 50, and 60 for both SAS and SATA drives

The LSX-BASE-500 configuration includes an SAS3801e-r HBA card in slot 5. This HBA supports eight SAS/SATA disk drives. The SAS3801e-r HBA supports RAID levels 0, 1E, and 10E.

The LSX-BASE-RAID5 configuration includes an MegaRAID 8708ELP PCIe card in slot 5. This HBA supports eight SAS/SATA disk drives. The MegaRAID 8708ELP card supports RAID levels 0, 1, 5, 6, 10, 50, and 60.

The Chassis can support up to eight 3.5" x 1" hot-swap SAS or SATA hard disk drives. The actual number of supported disk drives is configuration dependent. The disk drives are mounted to hot swap drive trays (see Figure 5-2).

Installing the Hard Drives



Figure 5-2 Removing the Hard Drive Carriers

The drives are mounted in driver carriers to simplify their installation and removal from the chassis.

**Note:** Drive blanks must be used when no disk drive is used in a hard drive bay. This is necessary to maintain proper cooling of the chassis.

If the MegaRAID 8708ELP RAID Controller option is configured in the C3108-TY11 an Intelligent Battery Backup Unit is included. The Battery Backup Unit will initiate a charge cycle automatically as normal operation. The charge cycle will disable cache and reduce transfer performance. Once the Charge cycle is completed, optimum performance will be returned automatically.

The Intelligent Battery Backup Unit (IBBU) protects the integrity of the cached data on the megaRAID controller for up to 72 hours in the event of a complete AC power failure or a brief power outage.

**Note:** Your operating system must have RAID support to enable the hot-plug capability of the drives.



**Important:** Regardless of how many hard drives are installed, all drive carriers must remain in the drive bays to maintain proper airflow.



**Caution:** Use caution when working around the SATA backplane. Do not touch the backplane with any metal objects and make sure no ribbon cables touch the backplane or obstruct the holes, which aid in proper airflow.

### **Removing the Hard Drive Carriers from the Chassis**

To remove the hard drive carriers, perform the following steps (see Figure 5-2):

- 1. Press the release button on the drive carrier. This extends the drive carrier handle.
- 2. Use the handle to pull the drive carrier out of the chassis.

### Installing a Hard Drive into the Hard Drive Carrier

To install a hard drive into the hard drive carrier, perform the following steps:

- 1. Remove the two screws securing the dummy drive to the drive carrier (see Figure 5-3).
- 2. Lift the dummy drive out of the drive carrier (see Figure 5-3).



Figure 5-3 Removing the Dummy Drive from the Carrier

- 3. Place the hard drive carrier on a flat, stable surface such as a desk, table, or work bench.
- 4. Slide the hard drive into the carrier with the printed circuit board side facing down (see Figure 5-4).
- 5. Carefully align the mounting holes in the hard drive and the carrier. Make sure the bottom of the hard drive and bottom of the hard drive carrier are flush.
- 6. Secure the hard drive using all six screws (see Figure 5-4).
- 7. Replace the drive carrier into the chassis. Make sure to close the drive carrier using the drive carrier handle.



Figure 5-4 Installing a Drive into a Hard Drive Carrier

# **PCI Expansion Slots**

There are seven PCI slot bays in the rear of the chassis. The PCI slots are located at the rear of the chassis - on the far right side. The slots are numbered from right to left (1 thru 7). All of the slots support full-height PCI cards. The following PCI slots are available:

- Two PCIe x16 Gen 2.0 card slots (slots 2 and 6)
- Four PCIe x8 Gen 2.0 card slots (slots 1, 3, 4, and 7)
- One PCIe x4 Gen 2.0 card slot (slot 5 is dedicated to the system RAID card)

See Figure 5-5 slot locations in the rear of the chassis.



Figure 5-5 PCI Slot Location

### Installing an Add-On or Expansion Card

- 1. To install add-on or expansion cards, perform the following steps:
- 2. Remove the chassis cover.
- 3. Locate the motherboard port aligned with the card slot you want to install,
- 4. Each slot is secured by one screw located on the top (inside) the chassis. Remove this screw.
- 5. Gently slide the expansion/add-on card into the correct motherboard slot. If the add-on card requires a riser card, install it at this time. If necessary, slide the card into the PCI card guide and lock it. Never force a component into a motherboard or the chassis.
- 6. Secure the expansion/add-on card with the screw from the I/O panel.

## **Chassis Maintenance**

This section describes basic chassis maintenance.

### System Fans

Five heavy-duty fans provide cooling for the chassis. These fans circulate air through the chassis as a means of lowering the internal temperature of the chassis. The SGI Rackable C3108-TY11 chassis includes three front fans and two rear fans (see Figure 5-6).

The SGI Rackable C3108-TY11 chassis fans are fully hot-swappable. In other words, fans may be removed and replaced without having to power down the server.



#### **Replacing a Front Fan**

To replace a front fan, perform the following steps:

- 1. Remove the top cover and locate the faulty fan. Never run the server for an extended period of time with the chassis open.
- 2. Press the release tab on the fan and pull the fan upward.
- 3. Slide the new fan into the fan housing. Make sure the power connectors are correctly aligned. The new fan will be immediately active.

Chassis Maintenance



Figure 5-7 Installing the Front Fan

#### **Replacing a Rear Fan**

To replace a rear fan, perform the following steps:

- 1. Remove the top cover and locate the faulty fan and remove it. Never run the server for an extended period of time with the chassis open.
- 2. Confirm that the air shroud is correctly placed.
- 3. Slide the rear fan into the slot as illustrated. The fan release tab should be on the side closest to the power supply.
- 4. Make sure that the fan is secure in the fan housing and the housing is correctly connected to the power supply.

5: Chassis Setup and Maintenance



Figure 5-8 Installing a Rear Fan

## Checking the System Air Flow

To check the SGI Rackable C3108-TY11 system air flow, perform the following steps:

- 1. Make sure there are no objects to obstruct airflow in and out of the server.
- 2. Do not operate the server without drives or drive trays in the drive bays.
- 3. Make sure no wires or foreign objects obstruct air flow through the chassis. Pull all excess cabling out of the airflow path or use shorter cables.

# **Power Supply**

The SGI Altix Rackable C3108-TY11 system has a 1200 watt switching power supply that operates from 100 - 240 volts AC and 50 - 60 Hz.

The power subject of the SGI Rackable C3108-TY11 server consists of an integrated power distribution module, a power module enclosure, and support for up to two power supply modules. The system can be configured with a single (1+0 non-redundant configuration) or dual power supply (N+1 configuration). Either configuration will support a maximum of 1200 watts of power.

The two power supplies are located in the left rear of the chassis.

In a single power supply configuration, the power supply is populated in the upper power supply slot. The non-operating slot must be filled with a power supply blank.

**Note:** The SGI Rackable C3108-TY11 will operate normally with a single power supply in either the top or bottom power supply bay. The top power supply bay is filled in systems configured with a single power supply.

#### **Replacing the Power Supply**

The power supply for the SGI Rackable C3108-TY11 system is redundant and hot-swappable. If you have this option (an additional power supply), you can replace the power supply with the system powered up, otherwise, the system must be powered off to replace the power supply.

To replace the power supply, perform the following steps:

- 1. The SGI Rackable C3108-TY11 system includes a redundant power supply (at least two power modules). The server may continue running if only one power supply module is removed at a time.
- 2. Unplug the power supply that will be replaced.
- 3. Push the release tab on the back of the power supply.
- 4. Pull the power supply out using the handle.
- 5. Replace the failed power module with another of the same model.
- 6. Push the new power supply module into the power bay until it clicks into the locked position.
- 7. Plug the AC power cord back into the module and power up the server.

## **Replacing the Slim DVD-ROM Drive**

To replace the slim 8x DVD-ROM, perform the following steps:

- 1. Power down and unplug the system.
- 2. Remove the chassis cover.
- 3. If a new front port panel is **not** being installed, remove the mini-bezel from the drive bay. The mini-bezel is the small grating that covers the drive bay. Remove this by simply pulling it out of the bay. If a new front port panel is being installed, remove the old drive by depressing the release tab, then pulling the drive out of the chassis.
- 4. Insert the new drive unit in the slot until the tab locks into place.
- 5. Connect the data and power cables to the backplane and, if necessary, the motherboard.

Chapter 6

# BIOS

This chapter describes the AMI BIOS Setup Utility for the SGI Rackable C3108-TY11 severboard. The AMI ROM BIOS is stored in a Flash EEPROM and can be easily updated. This chapter describes the basic navigation of the AMI BIOS Setup Utility setup screens.

# Starting BIOS Setup Utility

To enter the AMI BIOS Setup Utility screens, press the <Delete> key while the system is booting up.

**Note:** In most cases, the <Delete> key is used to invoke the AMI BIOS setup screen. There are a few cases when other keys are used, such as <F1>, <F2>, etc.

Each main BIOS menu option is described in this manual. The Main BIOS setup menu screen has two main frames. The left frame displays all the options that can be configured. Grayed-out options cannot be configured. Options in blue can be configured by the user. The right frame displays the key legend. Above the key legend is an area reserved for a text message. When an option is selected in the left frame, it is highlighted in white. Often a text message will accompany it.

**Note:** The AMI BIOS has default text messages built in. These text messages my be included, omitted, or changed across BIOS releases.

The AMI BIOS Setup Utility uses a key-based navigation system called "hot keys". Most of the AMI BIOS setup utility "hot keys" can be used at any time during the setup navigation process. These keys include <F1>, <F10>, <Enter>, <ESC>, arrow keys, etc.

Note: Options printed in Bold are default settings.

# How To Change the Configuration Data

The configuration data that determines the system parameters may be changed by entering the AMI BIOS Setup utility. This Setup utility can be accessed by pressing <Del> at the appropriate time during system boot.

# Starting the Setup Utility

Normally, the only visible Power-On Self-Test (POST) routine is the memory test. As the memory is being tested, press the <Delete> key to enter the main menu of the AMI BIOS Setup Utility. From the main menu, you can access the other setup screens. An AMI BIOS identification string is displayed at the left bottom corner of the screen below the copyright message.



Warning: Do not upgrade the BIOS unless your system has a BIOS-related issue. Flashing the wrong BIOS can cause irreparable damage to the system. In no event shall SGI be liable for direct, indirect, special, incidental, or consequential damages arising from a BIOS update. If you have to update the BIOS, do not shut down or reset the system while the BIOS is updating. This is to avoid possible boot failure.

## Main Setup

When you first enter the AMI BIOS Setup Utility, you will enter the Main setup screen. You can always return to the Main setup screen by selecting the Main tab on the top of the screen. The Main BIOS Setup screen is shown in Figure 6-1.

Hain Advanced Security	Boot Exit	
ystem Overview Use [ENTER], [TA		Use [ENIER], [TAB]
System Time System Date	E15:57:521 EFri 03/20/20091	use [+] or [-] to
Supermicro X8DTN BIOS Build Ver :1.0 BIOS Build Date :03/19/09 AMIBIOS Core Ver:08.00.15		configure system Time.
Processor Intel(R) Xeon(R) CPU Speed :2800MHz Physical Count :2 Logical Count :16 Microcode Rev :B System Memory Size :6136MB	X5560 @ 2.80GHz	<ul> <li>Select Screen</li> <li>Select Iten</li> <li>Change Field</li> <li>Select Field</li> <li>Field General Help</li> <li>Fi0 Save and Exit</li> <li>ESC Exit</li> </ul>
	100E 200C Anonteen Me	unduranda Tura

Figure 6-1 System Overview Main BIOS Setup Screen

## System Time/System Update

Use this option to change the system time and date. Highlight System Time or System. Date using the arrow keys. Key in new values through the keyboard and press <Enter>. Press the <Tab> key to move between fields. The date must be entered in Day MM/DD/YY format. The time is entered in HH:MM:SS format.

Note: The time is in the 24-hour format. For example, 5:30 P.M. appears as 17:30:00.

### Serverboard

• **BIOS Build Version**: This item displays the BIOS revision used in your system.

- **BIOS Build Date**: This item displays the date when this BIOS was completed.
- **AMI BIOS Core Version**: This item displays the revision number of the AMI BIOS Core upon which your BIOS was built.

#### Processor

The AMI BIOS will automatically display the status of the processor used in your system:

- **CPU Type**: This item displays the type of CPU used in the motherboard.
- **Speed**: This item displays the speed of the CPU detected by the BIOS.
- **Physical Count**: This item displays the number of processors installed in your system as detected by the BIOS.
- **Logical Count**: This item displays the number of CPU Cores installed in your system as detected by the BIOS.
- Micro\_code Revision: This item displays the revision number of the BIOS Micro\_code used in your system.

### System Memory

This displays the size of memory available in the system:

• Size: This item displays the memory size detected by the BIOS

# **Advanced Setup Configurations**

Use the arrow keys to select Boot Setup and hit <Enter> to access the submenu items shown in Figure 6-2.

Nain <mark>Advanced Security Boot Exit</mark>		
Advanced Settings WARNING: Setting wrong values in below sections may cause system to malfunction.	Select Boot Features	
<ul> <li>Boot Features</li> <li>Processor &amp; Clock Options</li> <li>Advanced Chipset Control</li> <li>IDE/SATA/Floppy Configuration</li> <li>PCL/PnP Configuration</li> <li>SuperIO Configuration</li> <li>Remote Access Configuration</li> <li>Hardware Health Configuration</li> <li>ACPI Configuration</li> <li>Trusted Computing</li> <li>IPMI Configuration</li> <li>DMI Event Logging</li> </ul>	<ul> <li>Select Screen</li> <li>Select Iten</li> <li>Enter Go to Sub Screen</li> <li>F1 General Help</li> <li>F10 Save and Exit</li> <li>ESC Exit</li> </ul>	
v02.61 (C)Copyright 1985-2006, American Megatrends, Inc.		

Figure 6-2 Advanced Settings Screen

## **Boot Features**

This section describes the Boot Features options.

#### **Quick Boot**

If Enabled, this option will skip certain tests during POST to reduce the time needed for system boot. The options are **Enabled** and Disabled.

Note: The default option is highlighted in bold face throughout this chapter.

#### 6: BIOS

Quiet Boot		
	This option allows the bootup screen options to be modified between POST messages or the OEM logo. Select Disabled to display the POST messages. Select Enabled to display the OEM logo instead of the normal POST messages. The options are <b>Enabled</b> and Disabled.	
AddOn ROM Display Mod	le	
	This sets the display mode for Option ROM. The options are Force BIOS and Keep Current.	
Bootup Num-Lock		
	This feature selects the Power-on state for Numlock key. The options are Off and <b>On.</b>	
Wait For 'F1' If Error		
	This forces the system to wait until the 'F1' key is pressed if an error occurs. The options are Disabled and <b>Enabled</b> .	
Hit 'Del' Message Display		
	This feature displays "Press DEL to run Setup" during POST. The options are <b>Enabled</b> and Disabled.	
Interrupt 19 Capture		
	Interrupt 19 is the software interrupt that handles the boot disk function. When this item is set to Enabled, the ROM BIOS of the host adaptors will "capture" Interrupt 19 at boot and allow the drives that are attached to these host adaptors to function as bootable disks. If this item is set to Disabled, the ROM BIOS of the host adaptors will not capture Interrupt 19, and the drives attached to these adaptors will not capture Set adaptors are Enabled and <b>Disabled</b> .	
Power Configuration		

This section describes power configuration options.
#### **Power Button Function**

If set to Instant\_Off, the system will power off immediately as soon as the user hits the power button. If set to 4\_Second\_Override, the system will power off when the user presses the power button for 4 seconds or longer. The options are **Instant\_Off** and 4\_Second\_Override.

#### **Restore on AC Power Loss**

Use this feature to set the power state after a power outage. Select Power-Off for the system power to remain off after a power loss. Select Power-On for the system power to be turned on after a power loss. Select Last State to allow the system to resume its last state before a power loss. The options are Power-On, Power-Off and Last State.

#### Watch Dog Timer

If enabled, the Watch Dog Timer will allow the system to reboot when it is inactive for more than 5 minutes. The options are Enabled and **Disabled**.

#### Processor and Clock Options

This submenu allows the user to configure the Processor and Clock settings.

#### **Ratio CMOS Setting**

This option allows the user to set the ratio between the CPU Core Clock and the FSB Frequency.

Note: If an invalid ratio is entered, the AMI BIOS will restore the setting to the previous state.

The default setting depends on the type of CPU installed on the motherboard. The default setting for the CPU installed in your motherboard is [21]. Press "+" or "-" on your keyboard to change this value.

#### **C1E Support**

Select Enabled to use the feature of Enhanced Halt State. C1E significantly reduces the CPU's power consumption by reducing the CPU's clock cycle and voltage during a "Halt State." The options are Disabled and **Enabled**.

#### 6: BIOS

#### Hardware Prefetcher (Available when supported by the CPU)

If set to Enabled, the hardware prefetcher will pre fetch streams of data and instructions from the main memory to the L2 cache in the forward or backward manner to improve CPU performance. The options are Disabled and **Enabled**.

#### Adjacent Cache Line Prefetch (Available when supported by the CPU)

The CPU fetches the cache line for 64 bytes if this option is set to Disabled. The CPU fetches both cache lines for 128 bytes as comprised if **Enabled**.

#### Intel Virtualization Technology (Available when supported by the CPU)

Select Enabled to use the feature of Virtualization Technology to allow one platform to run multiple operating systems and applications in independent partitions, creating multiple "virtual" systems in one physical computer. The options are **Enabled** and Disabled.

**Note:** If there is any change to this setting, you will need to power off and restart the system for the change to take effect. Please refer to Intel's web site for detailed information.

#### Execute-Disable Bit Capability (Available when supported by the OS and the CPU)

Set to Enabled to enable the Execute Disable Bit which will allow the processor to designate areas in the system memory where an application code can execute and where it cannot, thus preventing a worm or a virus from flooding illegal codes to overwhelm the processor or damage the system during an attack. The default is **Enabled**. (Refer to Intel and Microsoft Web Sites for more information.)

#### Simultaneous Multi-Threading (Available when supported by the CPU)

Set to Enabled to use the Simultaneous Multi-Threading Technology, which will result in increased CPU performance. The options are Disabled and **Enabled**.

#### **Active Processor Cores**

Set to Enabled to use a processor's Second Core and beyond. (Please refer to Intel's web site for more information.) The options are **All**, 1 and 2.

#### Intel EIST Technology

Enhanced Intel SpeedStep Technology (EIST) allows the system to automatically adjust processor voltage and core frequency in an effort to reduce power consumption and heat dissipation. Please refer to Intel's web site for detailed information. The options are **Disable (Disable GV3)** and Enable (Enable GV3).

#### Intel TurboMode Technology (Available when Intel EIST Technology is enabled)

Select Enabled to use the Turbo Mode to boost system performance. The options are **Enabled** and Disabled.

#### Intel C-STATE Tech

If enabled, C-State is set by the system automatically to either C2, C3 or C4 state. The options are **Disabled** and Enabled.

#### C-State package limit setting (Available when Intel® C-State Tech is enabled)

If set to Auto, the AMI BIOS will automatically set the limit on the C-State package register. The options are **Auto**, C1, C3, C6 and C7.

#### **C1** Auto Demotion

When enabled, the CPU will conditionally demote C3, C6 or C7 requests to C1 based on un-core auto-demote information. The options are Disabled and **Enabled**.

#### **C3** Auto Demotion

When enabled, the CPU will conditionally demote C6 or C7 requests to C3 based on un-core auto-demote information. The options are Disabled and **Enabled**.

#### **Clock Spread Spectrum**

Select Enable to use the feature of Clock Spectrum, which will allow the BIOS to monitor and attempt to reduce the level of Electromagnetic Interference caused by the components whenever needed. The options are **Disabled** and Enabled.

## Advanced Chipset Control

The items included in the Advanced Settings submenu are listed below:

### **CPU Bridge Configuration**

#### **QPI Links Speed**

This feature selects QPI's data transfer speed. The options are Slow-mode, and Full Speed.

## **QPI Frequency**

This selects the desired QPI frequency. The options are Auto, 4.800 GT, 5.866GT, 6.400 GT.

## QPI L0s and L1

This enables the QPI power state to low power. L0s and L1 are automatically selected by the motherboard. The options are **Disabled** and Enabled.

#### **Memory Frequency**

This feature forces a DDR3 frequency slower than what the system has detected. The available options are **Auto**, Force DDR-800, Force DDR-1066, and Force DDR-1333.

#### **Memory Mode**

The options are Independent, Channel Mirror, Lockstep and Sparing.

Independent - All DIMMs are available to the operating system.

Channel Mirror - The motherboard maintains two identical copies of all data in memory for redundancy.

Lockstep - The motherboard uses two areas of memory to run the same set of operations in parallel.

Sparing - A preset threshold of correctable errors is used to trigger fail-over. The spare memory is put online and used as active memory in place of the failed memory.

#### **Demand Scrubbing**

A memory error-correction scheme where the Processor writes corrected data back into the memory block from where it was read by the Processor. The options are Enabled and **Disabled**.

#### **Patrol Scrubbing**

A memory error-correction scheme that works in the background looking for and correcting resident errors. The options are Enabled and **Disabled**.

#### Memory ECC Error Threshold

This feature allows the user to set the correctable memory ECC error limit for AMI BIOS to handle it. The Default setting is 255.

### **Throttling - Closed Loop/Throttling - Open Loop**

Throttling improves reliability and reduces power in the processor by automatic voltage control during processor idle states. Available options are **Disabled** and Enabled. If Enabled, the following items will appear:

#### Hysteresis Temperature (Available for Closed Loop only)

Temperature Hysteresis is the temperature lag (in degrees Celsius) after the set DIMM temperature threshold is reached before Closed Loop Throttling begins. The options are Disabled, **1.5** degrees **C**, 3.0 degrees C, and 6.0 degrees C.

#### Guardband Temperature (Available for Closed Loop only)

This is the temperature which applies to the DIMM temperature threshold. Each step is in 0.5 degrees C increment. The default is **[006]**. Press "+" or "-" on your keyboard to change this value.

#### **Inlet Temperature**

This is the temperature detected at the chassis inlet. Each step is in 0.5 degrees C increment. The default is **[070]**. Press "+" or "-" on your keyboard to change this value.

#### **Temperature Rise**

This is the temperature rise to the DIMM thermal zone. Each step is in 0.5oC increment. The default is **[020]**. Press "+" or "-" on your keyboard to change this value.

#### **Air Flow**

This is the air flow speed to the DIMM modules. Each step is one mm/ sec. The default is **[1500]**. Press "+" or "-" on your keyboard to change this value.

#### Altitude

This feature defines how many meters above or below sea level the system is located. The options are **Sea Level or Below**, 1~300, 301~600, 601~900, 901~1200, 1201~1500, 1501~1800, 1801~2100, 2101~2400, 2401~2700, 2701~3000.

#### **DIMM Pitch**

This is the physical space between each DIMM module. Each step is in 1/1000 of an inch. The default is [400]. Press "+" or "-" on your keyboard to change this value.

#### Serial Debug Message Level

This feature allows the user to set the level of debug messages to be displayed. The options are **None**, MIN, MAX and Test.

## North Bridge Configuration

This feature allows the user to configure the settings for the Intel North Bridge chip.

#### Crystal Beach/Direct Memory Access (DMA)

This feature works with the Intel I/O Acceleration Technology (AT) to accelerate the performance of TOE devices.

**Note:** A TOE device is a specialized, dedicated processor that is installed on an add-on card or a network card to handle some or all packet processing of this add-on card.

When this feature is set to Enabled, it will enhance overall system performance by providing direct memory access for data transferring. The options are Enabled and **Disabled**.

#### Crystal Beach/ Direct Cache Access (DCA)

This feature is available when Crystal Beach/DMA is enabled. This feature works in conjunction with the Intel I/O AT to accelerate the performance of the TOE device. When this feature set to Enabled, it will enhance overall system performance by providing direct cache access for data transferring. The options are Enabled and **Disabled**.

#### Intel VT-d

Select Enabled to enable Intel's Virtualization Technology support for Direct I/O VT-d by reporting the I/O device assignments to VMM through the DMAR ACPI Tables.

This feature offers fully-protected I/O resource-sharing across the Intel platforms, providing the user with greater reliability, security and availability in networking and data-sharing. The settings are Enabled and **Disabled**.

## SouthBridge Configuration

This feature allows the user to configure the settings for the Intel ICH South Bridge chipset.

#### **USB** Functions

This feature allows the user to decide the number of onboard USB ports to be enabled. The Options are: Disabled, 2 USB ports, 4 USB ports, 6 USB ports, 8 Ports, 10 Ports and **12 USB ports**.

#### Legacy USB Support

Select Enabled to use Legacy USB devices. If this item is set to Auto, Legacy USB support will be automatically enabled if a legacy USB device is installed on the motherboard, and vise versa. The settings are Disabled, **Enabled** and Auto.

#### USB 2.0 Controller

This item indicated if the USB 2.0 controller is activated. The options are Enabled and Disabled.

#### **USB 2.0 Controller Mode**

This setting allows you to select the USB 2.0 Controller mode. The options are Hi-Speed (480 Mbps) and **Full Speed (12 Mbps)**.

#### **BIOS EHCI Hand-Off**

Select Enabled to enable BIOS Enhanced Host Controller Interface support to provide a workaround solution for an operating system that does not have EHCI Hand-Off support. When enabled, the EHCI Interface will be changed from the BIOS-controlled to the OS-controlled. The options are Disabled and **Enabled**.

#### Intel PCI-X Hub Configuration

#### PCI Bus A0/B0 Frequency

This option allows the user to set the maximum PCI speed to be used in the PCI slot specified. Select Auto to allow the BIOS to automatically detect the capability of the device installed on the bus. The options are **Auto**, 33 MHz PCI, 66 MHz PCI, 66 MHz PCI-X MI, 100 MHz PCI-X MI, and 133 MHz PCI-X MI.

### I/O Port Decode

This option allows the user to select the decode range for the I/O connections. The options are **4K Decode** and 1K Decode.

#### **RAS Sticky Error Handling**

This option allows the user to decide how to handle Sticky RAS errors. The options are **Clear Errors** and Leave Errors (unchanged).

## VGA 16-Bit Decode

Select Enabled to enable the function of decoding VGA for the devices installed behind the PXH PCI Controller Hub. The options are **Enabled** and Disabled.

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## **IDE and SATA Configuration**

When this submenu is selected, the AMI BIOS automatically detects the presence of the IDE devices and displays the following items:

#### SATA#1 Configuration

If Compatible is selected, it sets SATA#1 to legacy compatibility mode, while selecting Enhanced sets SATA#1 to native SATA mode. The options are Disabled, **Compatible**, and Enhanced.

#### Configure SATA#1 as

This feature allows the user to select the drive type for SATA#1. The options are **IDE**, RAID and AHCI. (When the option-RAID is selected, the item-ICH RAID Code Base will appear. When the option-AHCI is selected, the item-SATA AHCI will be available.)

#### ICH RAID Code Base (This feature is available when the option-RAID is selected)

Select Intel to enable Intel's SATA RAID firmware to configure Intel's SATA RAID settings. Select Adaptec to enable Adaptec's SATA RAID firmware to configure Adaptec's SATA RAID settings. The options are **Intel** and Adaptec.

#### SATA AHCI (This feature is available when the option-AHCI is selected)

Select Enable to enable the function of Serial ATA Advanced Host Interface. (Take caution when using this function. This feature is for advanced programmers only.) The options are Enabled and Disabled. If the option-Enabled is selected, the following item will display.

#### SATA#2 Configuration (This feature is available when the option-IDE is selected)

Selecting Enhanced will set SATA#2 to native SATA mode. The options are Disabled, and **Enhanced**.

#### **Primary IDE Settings**

# Primary IDE Master/Slave, Secondary IDE Master/Slave, Third IDE Master, and Fourth IDE Master

These settings allow the user to set the parameters of Primary IDE Master/Slave, Secondary IDE Master/Slave, Third and Fourth IDE Master slots. Hit <Enter> to activate the following

submenu screen for detailed options of these items. Set the correct configurations accordingly. The items included in the submenu are:

#### Type

Select the type of device connected to the system. The options are Not Installed, Auto, CD/DVD and ARMD.

#### LBA/Large Mode

LBA (Logical Block Addressing) is a method of addressing data on a disk drive. In the LBA mode, the maximum drive capacity is 137 GB. For drive capacities over 137 GB, your system must be equipped with a 48-bit LBA mode addressing. If not, contact your manufacturer or install an ATA/133 IDE controller card that supports 48-bit LBA mode. The options are Disabled and **Auto**.

#### **Block (Multi-Sector Transfer)**

Block Mode boosts the IDE drive performance by increasing the amount of data transferred. Only 512 bytes of data can be transferred per interrupt if Block Mode is not used. Block Mode allows transfers of up to 64 KB per interrupt. Select Disabled to allow data to be transferred from and to the device one sector at a time. Select Auto to allow data transfer from and to the device occur multiple sectors at a time if the device supports it. The options are **Auto** and Disabled.

#### **PIO Mode**

The IDE PIO (Programmable I/O) Mode programs timing cycles between the IDE drive and the programmable IDE controller. As the PIO mode increases, the cycle time decreases. The options are Auto, 0, 1, 2, 3, and 4.

Select Auto to allow the AMI BIOS to automatically detect the PIO mode. Use this value if the IDE disk drive support cannot be determined.

Select 0 to allow the AMI BIOS to use PIO mode 0. It has a data transfer rate of 3.3 MBs.

Select 1 to allow the AMI BIOS to use PIO mode 1. It has a data transfer rate of 5.2 MBs.

Select 2 to allow the AMI BIOS to use PIO mode 2. It has a data transfer rate of 8.3 MBs.

Select 3 to allow the AMI BIOS to use PIO mode 3. It has a data transfer rate of 11.1 MBs.

Select 4 to allow the AMI BIOS to use PIO mode 4. It has a data transfer bandwidth

of 32-Bits. Select Enabled to enable 32-Bit data transfer.

#### **DMA Mode**

Select Auto to allow the BIOS to automatically detect IDE DMA mode when the IDE disk drive support cannot be determined.

Select SWDMA0 to allow the BIOS to use Single Word DMA mode 0. It has a data transfer rate of 2.1 MBs.

Select SWDMA1 to allow the BIOS to use Single Word DMA mode 1. It has a data transfer rate of 4.2 MBs.

Select SWDMA2 to allow the BIOS to use Single Word DMA mode 2. It has a data transfer rate of 8.3 MBs.

Select MWDMA0 to allow the BIOS to use Multi Word DMA mode 0. It has a data transfer rate of 4.2 MBs.

Select MWDMA1 to allow the BIOS to use Multi Word DMA mode 1. It has a data transfer rate of 13.3 MBs.

Select MWDMA2 to allow the BIOS to use Multi-Word DMA mode 2. It has a data transfer rate of 16.6 MBs.

Select UDMA0 to allow the BIOS to use Ultra DMA mode 0. It has a data transfer rate of 16.6 MBs. It has the same transfer rate as PIO mode 4 and Multi Word DMA mode 2.

Select UDMA1 to allow the BIOS to use Ultra DMA mode 1. It has a data transfer rate of 25 MBs.

Select UDMA2 to allow the BIOS to use Ultra DMA mode 2. It has a data transfer rate of 33.3 MBs.

Select UDMA3 to allow the BIOS to use Ultra DMA mode 3. It has a data transfer rate of 66.6 MBs.

Select UDMA4 to allow the BIOS to use Ultra DMA mode 4. It has a data transfer rate of 100 MBs.

Select UDMA5 to allow the BIOS to use Ultra DMA mode 5. It has a data transfer rate of 133 MBs.

	Select UDMA6 to allow the BIOS to use Ultra DMA mode 6. It has a data transfer rate of 133 MBs. The options are Auto, SWDMAn, MWDMAn, and UDMAn.		
	S.M.A.R.T. For Hard disk drives		
	Self-Monitoring Analysis and Reporting Technology (SMART) can help predict impending drive failures. Select Auto to allow the AMI BIOS to automatically detect hard disk drive support. Select Disabled to prevent the AMI BIOS from using the S.M.A.R.T. Select Enabled to allow the AMI BIOS to use the S.M.A.R.T. to support hard drive disk. The options are Disabled, Enabled, and <b>Auto</b> .		
	32Bit Data		
	Select Enable to enable the function of 32-bit IDE data transfer. The options are <b>Enabled</b> and Disabled.		
Hot Plug			
	This feature is available when the option-AHCI Under "Confiigure SATA#1 as" is selected.		
	Select Enable to enable the hot plug function for the SATA devices. The options are <b>Enabled</b> and Disabled.		
IDE Detect Timeout (sec)			
	Use this feature to set the time-out value for the BIOS to detect the ATA, ATAPI devices installed in the system. The options are 0 (sec), 5, 10, 15, 20, 25, 30, and <b>35</b> .		
PCI/PnP Configuration			
Clear NVRAM			
	This feature clears the NVRAM during system boot. The options are No and Yes.		
Plug & Play OS			
	Selecting Yes allows the OS to configure Plug & Play devices. (This is not required for system boot if your system has an OS that supports Plug & Play.) Select <b>No</b> to allow the AMI BIOS to configure all devices in the system.		

#### **PCI Latency Timer**

This feature sets the latency Timer of each PCI device installed on a PCI bus. Select 64 to set the PCI latency to 64 PCI clock cycles. The options are 32, **64**, 96, 128, 160, 192, 224 and 248.

#### **PCI IDE BusMaster**

When enabled, the BIOS uses PCI bus mastering for reading/writing to IDE drives. The options are Disabled and **Enabled**.

#### Load Onboard LAN1 Option ROM/Load Onboard LAN2 Option ROM

Select Enabled to enable the onboard LAN1 or LAN2 Option ROM. This is to boot computer using a network interface. The options are Enabled and **Disabled**.

## **Super IO Device Configuration**

#### Serial Port1 Address/ Serial Port2 Address

This option specifies the base I/O port address and the Interrupt Request address of Serial Port 1 and Serial Port 2. Select Disabled to prevent the serial port from accessing any system resources. When this option is set to Disabled, the serial port physically becomes unavailable. Select 3F8/IRQ4 to allow the serial port to use 3F8 as its I/O port address and IRQ 4 for the interrupt address. The options for Serial Port1 are Disabled, 3F8/IRQ4, 3E8/IRQ4, 2E8/IRQ3. The options for Serial Port2 are Disabled, 2F8/IRQ3, 3E8/IRQ4, and 2E8/IRQ3.

### **Remote Access Configuration**

#### **Remote Access**

This allows the user to enable the Remote Access feature. The options are Disabled and Enabled.

If Remote Access is set to Enabled, the following items will display:

#### **Serial Port Number**

This feature allows the user decide which serial port to be used for Console Redirection. The options are **COM 1** and COM 2.

#### 6: BIOS

#### **Base Address, IRQ**

This item displays the based address and IRQ of the serial port specified above. The options are **COM 1** and COM 2.

#### Serial Port Mode

This feature allows the user to set the serial port mode for Console Redirection. The options are **115200 8, n 1**; 57600 8, n, 1; 38400 8, n, 1; 19200 8, n, 1; and 9600 8, n, 1.

#### **Flow Control**

This feature allows the user to set the flow control for Console Redirection. The options are **None**, Hardware, and Software.

#### **Redirection After BIOS POST**

Select Disabled to turn off Console Redirection after Power-On Self-Test (POST). Select Always to keep Console Redirection active all the time after POST.

Note: This setting may not be supported by some operating systems.

Select Boot Loader to keep Console Redirection active during POST and Boot Loader. The options are Disabled, Boot Loader, and **Always**.

#### **Terminal Type**

This feature allows the user to select the target terminal type for Console Redirection. The options are **ANSI**, VT100, and VT-UTF8.

#### VT-UTF8 Combo Key Support

A terminal keyboard definition that provides a way to send commands from a remote console. Available options are **Enabled** and Disabled.

#### Sredir Memory Display Delay

This feature defines the length of time in seconds to display memory information. The options are **No Delay**, Delay 1 Sec, Delay 2 Sec, and Delay 4 Sec.

## Hardware Health Monitor

This feature allows the user to monitor system health and review the status of each item as displayed.

#### **CPU Overheat Alarm**

This option allows the user to select the CPU Overheat Alarm setting which determines when the CPU OH alarm will be activated to provide warning of possible CPU overheat.



Warning: Any temperature that exceeds the CPU threshold temperature predefined by the CPU manufacturer may result in CPU overheat or system instability. When the CPU temperature reaches this predefined threshold, the CPU and system cooling fans will run at full speed. To avoid possible system overheating, please be sure to provide adequate airflow to your system.

The options are:

- The Early Alarm: Select this setting if you want the CPU overheat alarm (including the LED and the buzzer) to be triggered as soon as the CPU temperature reaches the CPU overheat threshold as predefined by the CPU manufacturer.
- The Default Alarm: Select this setting if you want the CPU overheat alarm including the LED and the buzzer) to be triggered when the CPU temperature reaches about 5 degrees C above the threshold temperature as predefined by the CPU manufacturer to give the CPU and system fans additional time needed for CPU and system cooling. In both the alarms above, please take immediate action as shown below.

#### **CPU Temperature/System Temperature**

This feature displays current temperature readings for the CPU and the System.

The following items will be displayed for your reference only:

#### **CPU** Temperature

The CPU thermal technology that reports absolute temperatures (Celsius/Fahrenheit) has been upgraded to a more advanced feature by Intel in its newer processors. The basic concept is each CPU is embedded by unique temperature information that the motherboard can read. This 'Temperature Threshold' or 'Temperature Tolerance' has been assigned at the factory and is the

baseline on which the motherboard takes action during different CPU temperature conditions (for example, by increasing CPU Fan speed, triggering the Overheat Alarm, etc). Since CPUs can have different 'Temperature Tolerances', the installed CPU can now send information to the motherboard what its 'Temperature Tolerance' is, and not the other way around. This results in better CPU thermal management.

The SGI Rackable C3108-TY11 system leverages this feature by assigning a temperature status to certain thermal conditions in the processor (Low, Medium and High). This makes it easier for the user to understand the CPU's temperature status, rather than by just simply seeing a temperature reading (for example, 25 degrees C). The CPU Temperature feature will display the CPU temperature status as detected by the BIOS:

**Low** – This level is considered as the 'normal' operating state. The CPU temperature is well below the CPU 'Temperature Tolerance'. The motherboard fans and CPU will run normally as configured in the BIOS (Fan Speed Control).

User intervention: No action required.

**Medium** – The processor is running warmer. This is a 'precautionary' level and generally means that there may be factors contributing to this condition, but the CPU is still within its normal operating state and below the CPU 'Temperature Tolerance'. The motherboard fans and CPU will run normally as configured in the BIOS. The fans may adjust to a faster speed depending on the Fan Speed Control settings.

User intervention: No action is required. However, consider checking the CPU fans and the chassis ventilation for blockage.

**High** – The processor is running hot. This is a 'caution' level since the CPU's 'Temperature Tolerance' has been reached (or has been exceeded) and may activate an overheat alarm.

User intervention: If the system buzzer and Overheat LED has activated, take action immediately by checking the system fans, chassis ventilation and room temperature to correct any problems.

**Note:** The system may shut down if it continues for a long period to prevent damage to the CPU. The information provided above is for your reference only. For more information on thermal management, please refer to Intel's web site at www.intel.com.

System Temperature

The system temperature will be displayed (in degrees in Celsius and Fahrenheit) as it is detected by the BIOS.

#### **Fan Speed Readings**

This feature displays the fan speed readings from Fan1 through Fan8.

#### **Fan Speed Control Monitor**

This feature allows the user to decide how the system controls the speeds of the onboard fans. The CPU temperature and the fan speed are correlative. When the CPU on-die temperature increases, the fan speed will also increase, and vice versa. Select Workstation if your system is used as a Workstation. Select Server if your system is used as a Server. Select "Disabled, (Full Speed @12V)" to disable the fan speed control function and allow the onboard fans to constantly run at the full speed (12V). The Options are: 1. **Disabled (Full Speed)**, 2. Server Mode, 3. Workstation Mode.

#### **Voltages Readings**

The following voltage readings will be displayed.

CPU1 Vcore, CPU2 Vcore, +5Vin, +12V, -12V 3.3Vcc (V), and Battery Voltage

## **ACPI Configuration**

Use this feature to configure Advanced Configuration and Power Interface (ACPI) power management settings for your system.

#### **ACPI Version Features**

The options are ACPI v1.0, ACPI v2.0 and ACPI v3.0. Please refer to ACPI's website for further explanation: http://www.acpi.info/.

#### **ACPI APIC Support**

Select Enabled to include the ACPI APIC Table Pointer in the RSDT (Root System Description Table) pointer list. The options are **Enabled** and Disabled.

#### APIC ACPI SCI IRQ

When this item is set to Enabled, APIC ACPI SCI IRQ is supported by the system. The options are Enabled and **Disabled**.

#### **Headless Mode**

This feature is used to enable system to function without a keyboard, monitor or mouse attached The options are Enabled and **Disabled**.

#### High Performance Event Timer

Select Enabled to activate the High Performance Event Timer (HPET) that produces periodic interrupts at a much higher frequency than a Real-time Clock (RTC) does in synchronizing multimedia streams, providing smooth playback and reducing the dependency on other timestamp calculation devices, such as an x86 RDTSC Instruction embedded in the CPU. The High Performance Event Timer is used to replace the 8254 Programmable Interval Timer. The options are Enabled and **Disabled**.

#### Trusted Computing

#### TCG/TPM Support

Select Yes on this item and enable the TPM jumper on the motherboard to enable TCG (TPM 1.1/1.2)/TPM support in order to improve data integrity and network security. The options are **No** and Yes.

If this feature is set to Yes, the following items will display:

#### **TPM Enable/Disable Status**

This item displays the status of TPM Support to indicate if TPM is currently enabled or disabled.

#### **TPM Owner Status**

This item displays the status of TPM Ownership.

## **IPMI** Configuration

Intelligent Platform Management Interface (IPMI) is a set of common interfaces that IT administrators can use to monitor system health and to manage the system as a whole. For more information on the IPMI specifications, please visit Intel's website at www.intel.com.

#### Status of BMC

Baseboard Management Controller (BMC) manages the interface between system management software and platform hardware. This is an informational feature which returns the status code of the BMC micro controller.

## View BMC System Event Log

This feature displays the BMC System Event Log (SEL). It shows the total number of entries of BMC System Events. To view an event, select an Entry Number and pressing <Enter> to display the information as shown in the screen.

- Total Number of Entries
- SEL Entry Number
- SEL Record ID
- SEL Record Type
- Timestamp, Generator ID
- Event Message Format User
- Event Sensor Type
- Event Sensor Number
- Event Dir Type
- Event Data

#### **Clear BMC System Event Log**

Select OK and press the <Enter> key to clear the BMC system log. Select Cancel to keep the BMC System log. The options are OK and Cancel.



**Caution:** Any cleared information is unrecoverable. Make absolutely sure that you no longer need any data stored in the log before clearing the BMC Event Log.

## Set LAN Configuration

Set this feature to configure the IPMI LAN adapter with a network address as shown in the following graphics.

**Channel Number** - Enter the channel number for the SET LAN Config command. This is initially set to [1]. Press "+" or "-" on your keyboard to change the Channel Number.

**Channel Number Status** - This feature returns the channel status for the Channel Number selected above: "Channel Number is OK" or "Wrong Channel Number".

## **IP Address Configuration**

Enter the IP address for this machine. This should be in decimal and in dotted quad form (i.e., 192.168.10.253). The value of each three-digit number separated by dots should not exceed 255 as shown in the screen below.

## **Parameter Selector**

Use this feature to select the parameter of your IP Address configuration.

#### IP Address

The BIOS will automatically enter the IP address of this machine; however it may be over-written. IP addresses are 6 two-digit hexadecimal numbers (Base 16, 0 ~ 9, A, B, C, D, E, F) separated by dots. (for example, 00.30.48.D0.D4.60).

#### **Current IP Address in BMC**

This item displays the current IP address used for your IPMI connection.

## **MAC Address Configuration**

Enter the Mac address for this machine. This should be in decimal and in dotted quad form (for example, 192.168.10.253). The value of each three-digit number separated by dots should not exceed 255.

#### **Parameter Selector**

Use this feature to select the parameter of your Mac Address configuration.

#### Mac Address

The BIOS will automatically enter the Mac address of this machine; however, it may be over-ridden. Mac addresses are 6 two-digit hexadecimal numbers (Base 16, 0 ~ 9, A, B, C, D, E, F) separated by dots. (i.e., 00.30.48.D0.D4.60).

#### **Current Mac Address in BMC**

This item displays the current Mac address used for your IPMI connection.

## **Subnet Mask Configuration**

Subnet masks tell the network which subnet this machine belongs to. The value of each three-digit number separated by dots should not exceed 255.

#### **Parameter Selector**

Use this feature to select the parameter of your Subnet Masks configuration.

#### Subnet Mask

This item displays the current subnet mask setting for your IPMI connection.

# SEL PEF Configuration **PEF Support** Select Enabled to enable the function of Platform Event Filter (PEF) which will interpret BMC events and perform actions based on pre-determined settings or events and performs actions based on pre-determined settings or 'traps' under IPMI 1.5 specifications. For example, powering the system down or sending an alert when a triggering event is detected. The default is **Disabled**. **PEF Action Global Control** Note: Available if the item-PEF Support is enabled. These are the different actions based on BMC events. The options are Alert, Power Down, Reset System, Power Cycle, OEM Action, Diagnostic Interface. Alert Startup Delay Note: Available if the item-PEF Support is enabled. This feature inserts a delay during startup for PEF alerts. The options are Enabled and Disabled. **PEF Alert Startup Delay** Note: Available if the item-PEF Support is enabled. This sets the pre-determined time to delay PEF alerts after system power-ups and resets. Refer to Table 24.6 of the IPMI 1.5 Specification for more information at www.intel.com. The options are No Delay, 30 sec, 60 sec, 1.5 min, 2.0 min. Startup Delay Note: Available if the item-PEF Support is enabled.

6: BIOS

This feature enables or disables startup delay. The options are Enabled and Disabled.

#### **PEF Startup Delay**

Note: Available if the item-PEF Startup is enabled.

This sets the pre-determined time to delay PEF after system power-ups and resets. Refer to Table 24.6 of the IPMI 1.5 Specification for more information at www.intel.com. The options are No Delay, 30 sec, 60 sec, 1.5 min, 2.0 min.

Event Message for PEF Action

Note: Available if the item-PEF Support is enabled.

This enables of disables Event Messages for PEF action. Refer to Table 24.6 of the IPMI 1.5 Specification for more information at www.intel.com. The options are **Disabled** and Enabled.

### **BMC Watch Dog Timer Action**

Allows the BMC to reset or power down the system if the operating system hangs or crashes. The options are Disabled, Reset System, Power Down, Power Cycle.

#### BMC Watch Dog TimeOut [Min:Sec]

This option appears if BMC Watch Dog Timer Action (above) is enabled. This is a timed delay in minutes or seconds, before a system power down or reset after an operating system failure is detected. The options are **[5 Min]**, [1 Min], [30 Sec], and [10 Sec].

## **DMI Event Log**

#### **View Event Log**

Use this option to view the System Event Log.

#### Mark all events as read

This option marks all events as read. The options are OK and Cancel.

## **Clear event log**

This option clears the Event Log memory of all messages. The options are OK and Cancel.

## **Security Settings**

The AMIBIOS Setup Utility provides a Supervisor and a User password. If you use both passwords, the Supervisor password must be set first. See Figure 6-3.



Figure 6-3 Security Settings Screen

This feature indicates if a supervisor's password has been entered (installed).

## **User Password**

This feature indicates if a user's password has been entered (installed).

#### **Change Supervisor Password**

Select this option and press <Enter> to access the submenu, and then enter the password.

#### **Change User Password**

Select this option and press <Enter> to access the submenu, and then enter the password.

#### **Clear User Password**

Note: Available only if User Password has been set.

This item allows you to clear a user password after it has been entered.

#### **Password Check**

This item allows you to check a password after it has been entered. The options are **Setup** and Always.

## **Boot Sector Virus Protection**

When Enabled, the AMI BIOS displays a warning when any program (or virus) issues a Disk Format command or attempts to write to the boot sector of the hard disk drive. The options are Enabled and **Disabled**.

## **Boot Configuration**

Use this feature to configure boot settings (see Figure 6-4).



Figure 6-4 Boot Settings Screen

## **Boot Device Priority**

This feature allows the user to specify the sequence of priority for the Boot Device. The settings are 1st boot device, 2nd boot device, 3rd boot device, 4th boot device, 5th boot device and Disabled.

- 1st Boot Device [USB: XXXXXXXX]
- 2nd Boot Device [CD/DVD: XXXXXXXX]

## **Hard Disk Drives**

This feature allows the user to specify the boot sequence from all available hard disk drives. The settings are Disabled and a list of all hard disk drives that have been detected (for example, 1st Drive, 2nd Drive, 3rd Drive, etc).

• 1st Drive - [SATA: XXXXXXXX]

## **Removable Drives**

This feature allows the user to specify the boot sequence from available Removable Drives. The settings are 1st boot device, 2nd boot device, and Disabled.

- 1st Drive [USB: XXXXXXXX]
- 2nd Drive

## **Exit Options**

Select the Exit tab from the AMI BIOS Setup Utility screen to enter the Exit BIOS Setup screen. See Figure 6-5.



Figure 6-5 Exit Options Screen

## Save Changes and Exit

When you have completed the system configuration changes, select this option to leave the BIOS Setup Utility and reboot the computer, so the new system configuration parameters can take effect. Select Save Changes and Exit from the Exit menu and press <Enter>.

## **Discard Changes and Exit**

Select this option to quit the BIOS Setup without making any permanent changes to the system configuration, and reboot the computer. Select Discard Changes and Exit from the Exit menu and press <Enter>.

## **Discard Changes**

Select this option and press <Enter> to discard all the changes and return to the AMI BIOS Utility Program.

## Load Optimal Defaults

To set this feature, select Load Optimal Defaults from the Exit menu and press <Enter>. Then, select OK to allow the AMI BIOS to automatically load Optimal Defaults to the BIOS Settings. The Optimal settings are designed for maximum system performance, but may not work best for all computer applications.

## Load Fail-Safe Defaults

To set this feature, select Load Fail-Safe Defaults from the Exit menu and press <Enter>. The Fail-Safe settings are designed for maximum system stability, but not for maximum performance.

## Appendix A BIOS Error Codes

During Power-On Self-Test (POST) routines, which are performed each time the system is powered on, errors may occur.

Non-fatal errors are those which, in most cases, allow the system to continue the boot-up process. The error messages normally appear on the screen.

Fatal errors are those which will not allow the system to continue the boot-up procedure. If a fatal error occurs, you should consult with your system manufacturer for possible repairs.

These fatal errors are usually communicated through a series of audible beeps. The numbers on the fatal error list correspond to the number of beeps for the corresponding error.

Beep Code	Error Message	Description
1 beep	Refresh	Circuits have been reset.(Ready to power up)
5 short beeps + 1 long beep	Memory error	No memory detected in the system
8 beeps	Display memory read/write error	Video adapter missing or with faulty memory
1 continuous beep with the front panel OH LED on	System Overheat	1 continuous beep with the front panel OH LED on

Table A-1BIOS Error Codes